

RoHS

COMPLIANT HALOGEN

Available

MI4835-VB Datasheet P-Channel 30-V (D-S) MOSFET

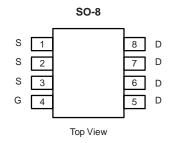
PRODUCT SUMMARY				
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^d	Q _g (Typ.)	
- 30	0.018 at V _{GS} = - 10 V	- 9.0	13 nC	
- 30	0.024 at V _{GS} = - 4.5 V	- 7.8	13110	

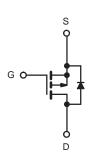
FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- Trench Power MOSFET
- 100 % R_g Tested

APPLICATIONS

- Load Switch
- Battery Switch





P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	A = 25 °C, unless othe	erwise noted		
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	- 30	V	
Gate-Source Voltage	V _{GS}	± 20	v	
	T _C = 25 °C		- 9.0	
Continuous Drain Current (T ₁ = 150 °C)	T _C = 70 °C		- 7.2	
Continuous Drain Current $(1) = 150$ C)	T _A = 25 °C		- 7.0 ^{a, b}	
	T _A = 70 °C		- 5.6 ^{a, b}	A
Pulsed Drain Current	I _{DM}	- 30		
Continuous Courses Drain Diada Coursest	T _C = 25 °C		- 3.5	
Continuous Source-Drain Diode Current	T _A = 25 °C	Is –	- 2.1 ^{a, b}	
	T _C = 25 °C		4.2	
Manian and Disain stick	T _C = 70 °C		2.7	w
Maximum Power Dissipation	T _A = 25 °C	P _D	2.5 ^{a, b}	VV
	T _A = 70 °C	1	1.6 ^{a, b}	
Operating Junction and Storage Temperature Rang	T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{a, c}	t ≤ 10 s	R _{thJA}	40	50	°C/W	
Maximum Junction-to-Foot	Steady State	R _{thJF}	24	30	0,00	

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. t = 10 s.

c. Maximum under Steady State conditions is 95 °C/W.

d. Based on $T_C = 25 \text{ °C}$.

SPECIFICATIONS T _J = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = - 250 μA	- 30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = - 250 μA		- 31			
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	i _D = - 250 μA		4.5		mV/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1.0		- 2.5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zara Cata Valtaga Drain Current	la a a	$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1		
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 \text{ °C}$			- 5	μA	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le$ - 5 V, V_{GS} = - 10 V	- 20			А	
Drain Source On State Desistenced	Rea()	V_{GS} = - 10 V, I _D = - 7.0 A		0.018		0	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V_{GS} = - 4.5 V, I _D = - 5.6 A		0.024		Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 7.0 A		18		S	
Dynamic ^b							
Input Capacitance	C _{iss}			1455			
Output Capacitance	C _{oss}	V_{DS} = - 15 V, V_{GS} = 0 V, f = 1 MHz		180		pF	
Reverse Transfer Capacitance	C _{rss}			145			
Total Gate Charge	Q _g	V_{DS} = - 15 V, V_{GS} = - 10 V, I_{D} = - 7.0 A		25	38	nC	
Iotal Gale Charge	•	•		13	20		
Gate-Source Charge	Q _{gs}	$V_{DS} = -15$ V, $V_{GS} = -4.5$ V, $I_{D} = -7.0$ A		3.5			
Gate-Drain Charge	Q _{gd}			5.5			
Gate Resistance	R _g	f = 1 MHz	0.4	2.0	4.0	Ω	
Turn-On Delay Time	t _{d(on)}			10	20		
Rise Time	t _r	V_{DD} = - 15 V, R_L = 2.7 Ω		13	20		
Turn-Off DelayTime	t _{d(off)}	$\text{I}_\text{D}\cong$ - 5.6 A, V_GEN = - 10 V, R_g = 1 Ω		23	35		
Fall Time	t _f			9	18	ns	
Turn-On Delay Time	t _{d(on)}			38	57	115	
Rise Time	t _r	V_{DD} = - 15 V, R_L = 2.7 Ω		89	134		
Turn-Off DelayTime	t _{d(off)}	$I_{D}\cong$ - 5.6 A, V_{GEN} = - 4.5 V, R_{g} = 1 Ω		22	33		
Fall Time	t _f			11	17		
Drain-Source Body Diode Characteristics							
Continous Source-Drain Diode Current	۱ _S	T _C = 25 °C			- 6.5	Α	
Pulse Diode Forward Current	I _{SM}				- 30		
Body Diode Voltage	V _{SD}	$I_{S} = -5.6 \text{ A}, V_{GS} = 0 \text{ V}$		- 0.71	- 1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			22	33	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = - 5.6 A, dl/dt = 100 A/µs, T ₁ = 25 °C		17	26	nC	
Reverse Recovery Fall Time	t _a	F = -3.5 A, and = -100 A		13		ns	
Reverse Recovery Rise Time				9		115	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

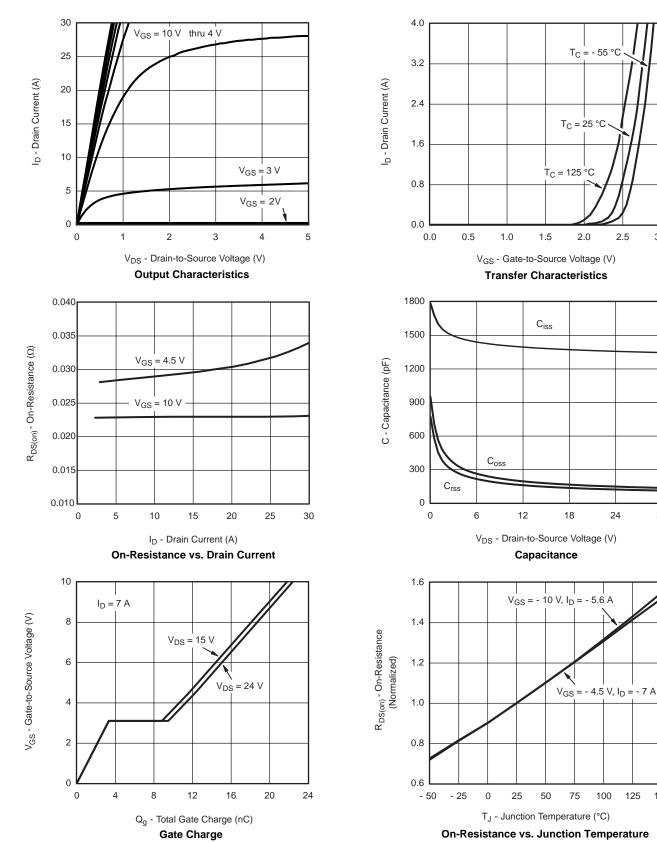
semi

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3.0

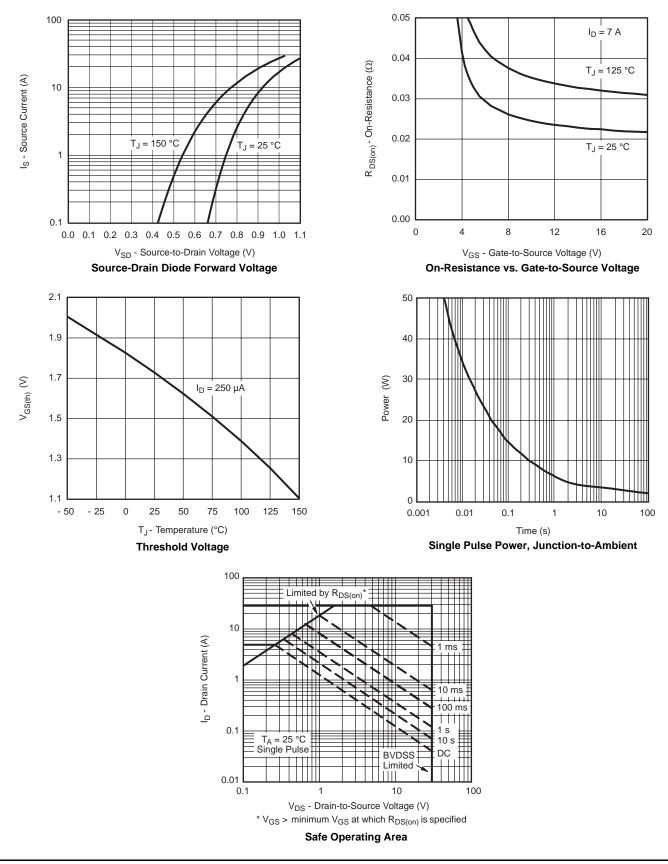
30



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

150

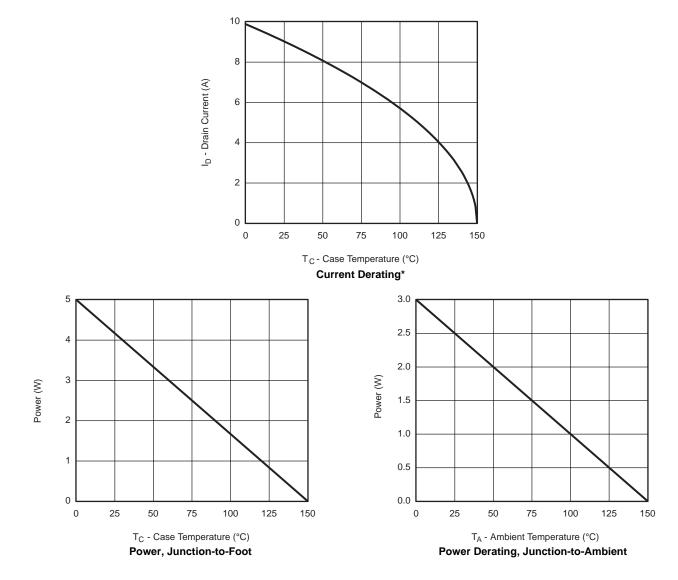




TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



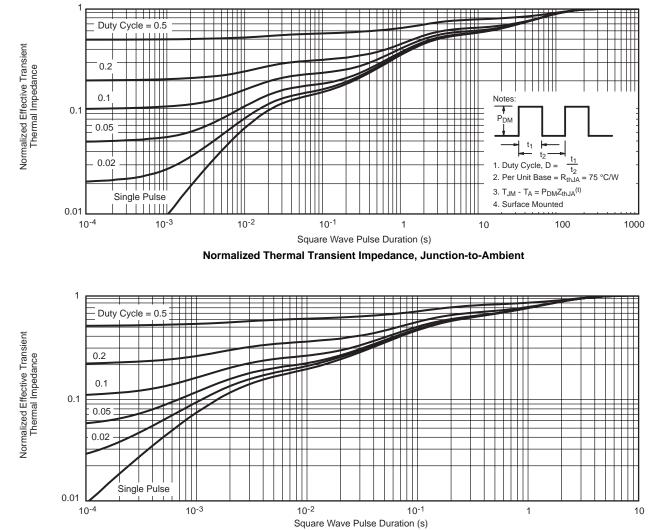
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





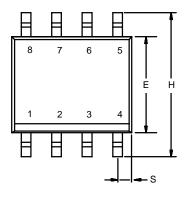


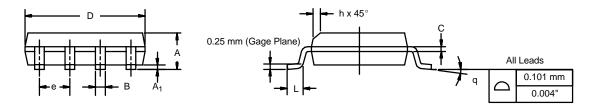
Normalized Thermal Transient Impedance, Junction-to-Foot



SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012

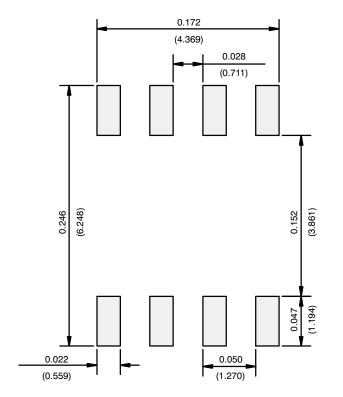




	MILLIM	ETERS	INCHES			
DIM	Min	Мах	Min	Max		
A	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27	1.27 BSC		0.050 BSC		
н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498						



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)



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